



2022 International Conference on Electronics Packaging
(ICEP 2022)

Date: May 11-14, 2022

Venue: Sapporo Community Plaza, Hokkaido

Strain-Induced Change in the Photonic Properties of Dumbbell-Shaped Graphene Nanoribbon Structures

Jowesh Avisheik Goundar¹, Ken Suzuki², and Hideo Miura²

¹ Department of Finemechanics, Graduate School of Engineering, Tohoku University, Sendai, Japan

² Fracture and Reliability Research Institute, Tohoku University, Sendai, Japan